

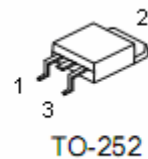
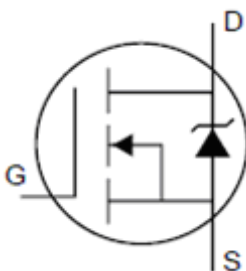
1.Features

- n Advanced trench process technology
- n High density cell design for ultra low on-resistance
- n Fully characterized avalanche voltage and current

2.Applications

- n $V_{DS}=30V, R_{DS(on)}=8.0m\Omega, I_D=50A$
- n $V_{ds}=30V$
- n $R_{DS(on)}=8.0m\Omega(Max.), V_{GS}@10V, I_{ds}@30A$
- n $R_{DS(on)}=9.5m\Omega(Max.), V_{GS}@4.5V, I_{ds}@30A$

3. Pin configuration



Pin	Function
1	Gate
2	Drain
3	Source
4	Drain

4. Maximum ratings and thermal characteristics

(Ta=25°C, unless otherwise notes)

Rating		Symbol	Value	Unit
Drain-source voltage		V _{DS}	30	V
Gate-source voltage		V _{GS}	±20	V
Continuous drain current		I _D	50	A
Pulsed drain current ¹⁾		I _{DM}	200	A
Maximum power dissipation	T _A =25°C	P _D	60	W
	T _A =75°C	P _D	23	W
Operating junction and storage temperature range		T _J /T _{STG}	-55 to 150	°C
Junction-to-case thermal resistance		R _{θJC}	1.8	°C/W
Junction-to ambient thermal rasistance (PCB mount) ²⁾		R _{θJA}	50	°C/W

Note: 1. Repetitive rating; pulse width limited by the maximum junction temperature

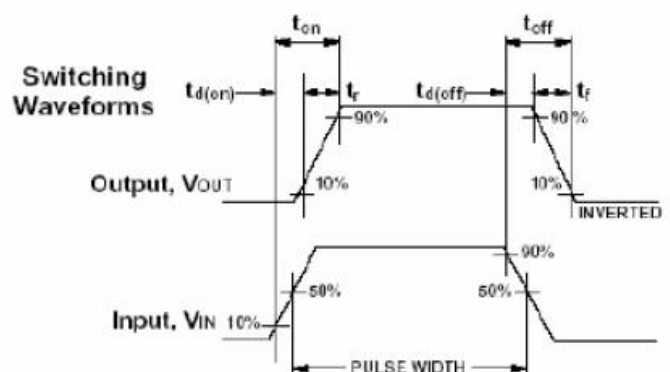
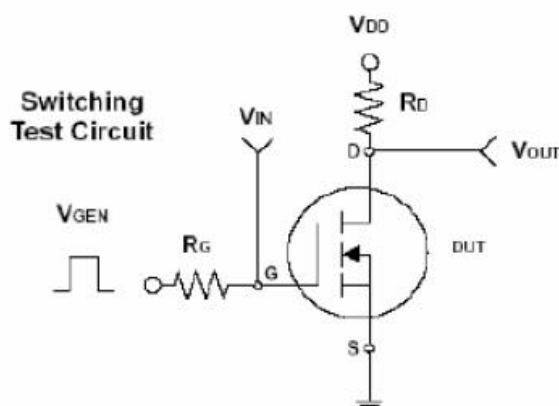
2. 1-in² 2oz Cu PCB board

3. Guaranteed by design; not subject to production testing

5. Ordering information

Part number	Package
50N03	TO-252

6. Typical application circuit



7. Electrical characteristics

(Ta=25°C, unless otherwise notes)

Parameter	Symbol	Test conditions	Min.	Typ.	Max.	Units
Static						
Drain-source breakdown voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
Drain-source on-state resistance	$R_{DS(ON)}$	$V_{GS}=4.5V, I_D=30A$	-	9.5	13.0	mΩ
		$V_{GS}=10V, I_D=30A$	-	8.0	9.0	mΩ
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	1	1.8	3	V
Forward transconductance	g_{fs}	$V_{DS}=15V, I_D=15A$	-	12	-	S
Zero gate voltage drain current	I_{DSS}	$V_{DS}=25V, V_{GS}=0V$	-	-	1	μA
Gate-source forward leakage	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	±100	nA
Dynamic ³⁾						
Total gate charge	Q_g	$I_D=35A$ $V_{DS}=15V$ $V_{GS}=10V$	-	10	25	nC
Gate-source charge	Q_{gs}		-	3.5	10	nC
Gate-drain ("miller") charge	Q_{gd}		-	3	65	nC
Turn-on delay time	$t_{d(off)}$	$V_{DD}=15V$ $I_D=1A$ $R_G=6\Omega$ $R_L=15\Omega$ $V_{GEN}=10V$	-	12	-	ns
Rise time	t_r		-	4	-	ns
Turn-off delay time	$t_{d(off)}$		-	32	-	ns
Fall time	t_f		-	6	-	ns
Input capacitance	C_{iss}	$V_{GS}=0V$ $V_{DS}=15V$ $f=1.0MHz$	-	1180	-	pF
Output capacitance	C_{oss}		-	270	-	pF
Reverse transfer capacitance	C_{rss}		-	145	-	pF

Source-drain diode

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Units
Diode forward voltage	V_{SD}	$I_S=20A, V_{GS}=0V$	-	0.87	1.5	V
Max.diode forward current	I_S		-	-	20	A

Notes: Pulse width ≤ 300μs, duty cycle ≤ 2%